	COUNT	DESCRIPTION OF	F REVI	SIONS	BY	CHKD	DATE		COUR	"	DESCRIP	TION OF RE	A1910N2	BY	CHKD	DA	\IE
À								ļĄ									
Δ																	
APF	PLICA	BLE STANDARI	<u> </u>														
RATING		Operating Temperature Rang		nge -55 C to 105 C (Note I) Te					Ter		perature Range					3)	
		Operating Humio Range	lity	20% to 80% (Note2)							orage Humidity nge 40% to 70% (Note3)						
		Applicable Con							Cur	AWG 30 : 0.5A AV Current AWG 26 : 1.5A			AW	VG 28 : 1A			
		Voltage							ou.	AWG 22-24 : 2A							
	SPECIFICATIONS																
ITEM TEST METHOD REQUIREMENTS QT A											ΑТ						
CO		UCTION	I														
General Examination Visually and by measuring instrument.										0							
Mark					-					-	According	to drawing.				0	0
· · · · · · · · · · · · · · · · · · ·																	
ELECTRICAL CHARACTERISTICS Contact Resistance 20mV MAX, 1mA (DC or 1000Hz). 30 mΩ MAX.											1						
			20mV MAX, 1mA (DC or 1000Hz).							1	30 mΩ MA	AX.				0	_
_		el Method															
Insulation Resistance			500 V DC.								1,000 MΩ MIN.				0	-	
Voltage Proof			650 V AC for 1 min.								No flashover or breakdown.				0	-	
MECHANICAL CHARACTERISTICS											<u></u>						
Meck	nanical (Operation	30 times insertion and extraction.						(①Contact resistance: 30mΩ MAX							
		(Sn Plating)							(②No damage, crack or looseness of parts.				0	-		
Meck	nanical (Operation	50 times insertion and extraction.							(①Contact resistance: 30mΩ MAX						
		(Au Plating)									②No damage, crack or looseness of parts.					0	_
		(, (a. , (a. a. , (a.)									O * * * * * * * * * * * * * * * * * * *						
Matir	ng and u	nmating	It takes out and inserts with a conformity connector.						or.	: ①Insertion Force: 96.2N MAX							
Mating and unmating force (Sn Plating)											②Extraction Force: 5.7N MIN				0	_	
10100		(Off Fideling)															
Matir	ng and u	nmating	It take	It takes out and inserts with a conformity connector.							①Insertion Force: 61.2N MAX						
Mating and unmating force (Au Plating)											②Extraction Force: 5.5N MIN				0	_	
10100	•	(Au Flacing)															
Vibration			Frequency 10 to 55 Hz, single amplitude 0.75 mm,							. (1)No electrical discontinuity of 1 μ s.						
Vibration											②No damage, crack or looseness of parts.				0	_	
Shoo	.k		at 10 cycles for 3 direction. Acceleration 490 m/s ² duration of pulse 11 ms at 3							_							
SHOC	, N						tion of pt	iise i	i ilis a	١٥	1					0	_
			times for 3 directions.								!						
ENI	/IDON	IMENITAL OU	NDAC	TEDI	OTIO	•											
		IMENTAL CHA							۸, ۵۵,	- 1.	<u> </u>						
Damp Heat (Steady State)			Exposed at 40 ± 2 °C , humidity 90 to 95 %, 96 h. (After leaving the room temperature for 1 to 2h.)								①Contact resistance: 30 mΩ MAX.				0	_	
											②Insulation resistance: 500MΩ MIN. ③No damage, crack or looseness of parts.						
										(3)No dam	age, crack or	looseness	of part	s.		
Rema		de the temperature	ricina	by our	ont												
		ondensing	, i ionig	by Curr	OTIC.												
		_	of long t	term sto	orage fo	r unus	ed produ	cts be	efore p	cb or	n board, at	fter pcb board	, operatir	g temp	erature	and	
Note 3: Apply to the condition of long term storage for unused products before pcb on board, after pcb board, operating temperature and humidity range is applied for interim storage during transportation.																	
												T					
								DRAV	VN		DESIGNED	CHECKE	ED AF	PROVE	D F	RELEAS	SED
						_						0 M I M 4 T 0 1/1/10			FILE	<u> </u>	
						J	J.S CHOI		J	J.S CHOI S		Λ.LIM			ENG	— 1	
						١,	10.00.00			10 02 02					20. 02.		
Unless otherwise specified, refer to IEC 60512.						י ן י	18.03.02			18.03.02 18.03.02			18.03.02 DEPT			ゾ 【	
					20115					<u> </u>							
NOT	Ŀ QT	QUALIFICATION	IEST	AT: AS	SURA	NCE TE	:ST 0: /	YPPL	ICABL	E TE	:ST	DADT 1/2					
	HIRC	SE KOREA CO	חדו			SPF	CIFICA.	LIUV	SHE	FT		PART NO.					
				•		<u> </u>		IFICATION SHEET			·' <u> </u>		F51K-22DP-2DS(800)				
CODE NO.(OLD)				DRAWI	WING NO.			CODE NO				<u> </u>	CL 6652-0049-8-800				1
CI					FI C	4-632	485		I			OL (JUUZ-UU	TJ "O"	000		1/2

Rapid Change of	Temperature -55 °C → $+105$ °C	①Contact resistance: 30 mΩ MAX.		
Temperature	Time 30min → 30min	②Insulation resistance: 1,000M Ω MIN.	0	_
	Under 5 Cycles.	③No damage, crack or looseness of parts.		
	(The transferring time of the tank is 2 to 3 MIN)			
	(After leaving the room temperature for 1 to 2h.)			
Dry Heat	Exposed at 105±2 °C, 96h	①Contact resistance: 30 mΩ MAX.		
		②Insulation resistance: 1,000M Ω MIN.	0	_
		③No damage, crack or looseness of parts.		
Cold	Exposed at -55±3 °C, 96h	①Contact resistance: 30 mΩ MAX.		
		②Insulation resistance: 1,000M Ω MIN.	0	_
		③No damage, crack or looseness of parts.		
Resistance To Soldering	①Automatic soldering (flow)	No deformation of case of excessive looseness		
Heat	Soldered at solder temperature,	of the terminals.		
	260 °C for in immersion , duration, 5 s.			
	②Manual soldering		0	_
	Soldering iron temperature :270 °C,			
	Soldering time :3s.			
	No strength on contact.			
Solderability	Soldering temperature: 245 °C	New uniform coating of solder shall cover		
	Duration of immersion :soldering, for 5 sec.	minimum of 95 % of the surface Being	0	
		immersed.		

NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST									
LUDOOF KODEA OO LED		ODEOJEJOATION	OUEET	PART NO.					
HIROSE KOREA CO.,LTD	٠.	SPECIFICATION	SHEET	DF51K-22DP-2DS(800)					
CODE NO.(OLD)	DRAWING NO).	CODE NO.	CL 6652-0049-8-800	2 /				
CL	EL	.C4-632485		OL 0032-0049-6-600					